

UMB05F THRU UMB10F

Ultra Miniature Glass Passivated Single-Phase Surface Mount Flat Bridge Rectifier

Features

- Low profile space
- Ideal for automated placement
- Glass passivated chip junction
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- High temperature soldering: 260℃/10 seconds at terminals
- Component in accordance to RoHS 2002/95/1 and WEEE 2002/96/EC

Mechanical Date

- **Case:** SOF2-4 Molded plastic over glass passivated chip
- Terminals: Solder plated, solderable per J-STD-002B and JESD22-B102D
- Polarity: Polarity symbols marked on body

Maximum Ratings & Thermal Characteristics (T_A = 25 °C unless otherwise noted)

Items	Symbol	UMB 05F	UMB 1F	UMB 2F	UMB 4F	UMB 6F	UMB 8F	UMB 10F	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current				-					
at T_A =30°C -on glass-epoxy P.C.B ⁽¹⁾ -on aluminum substrate ⁽²⁾	I _{F(AV)}	0.5 0.8							A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	20						A	
Typical Current Squared Time	l ² t	1.66						A ² S	
Thermal resistance from junction to ambient per leg	${\sf R}_{ heta JA}{}^{(1)}$	100 80							°C/W
Thermal resistance from junction to lead per leg ⁽¹⁾	$R_{ extsf{ heta}JL}$	30						°C /W	
Operating junction and storage temperature range	T _J ,T _{STG}	–55 to +150						°C	

Note 1: On glass epoxy P.C.B. mounted on 0.06×0.04 $^{\prime\prime}$ (1.5×1.1mm) pads

Note 2: On aluminum substrate P.C.B. with an area of 0.8×0.8 " (20×20mm) mounted on 0.06×0.04 " (1.5×1.1mm) solder pad

Electrical Characteristics (T_A = 25 °C unless otherwise noted)

Items	Symbol	Min	Туре	Мах	UNIT	
Instantaneous forward voltage per	V _F	-	0.96	1.10	V	
$ \begin{array}{c c} \mbox{Reverse current per leg } V_{R} \mbox{=} V_{DC} & T_{j} \mbox{=} 2 \\ T_{j} \mbox{=} 12 \end{array} $		I _R	-	-	5 100	uA
Reverse Recovery Time (Note 2)	Trr	-	2	-	uSec	

SOF2-4



Notes: 1.Pulse test :300 us pulse width,1% duty cycle.

2.Test Conditions: IF= 0.5A, IR= -1.0A, IRR= -0.25A.

RATING AND CHARACTERISTICS CURVES (UMB05F THRU UMB10F)











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PACKAGE OUTLINE

Plastic surface mounted package; 4 leads



The recommended mounting pad size



Marking



Type number	Marking code				
UMB05F	B1				
UMB1F	B2				
UMB2F	В3				
UMB4F	B4				
UMB6F	B5				
UMB8F	B6				
UMB10F	В7				



PACKAGING OF DIODE AND BRIDGE RECTIFIERS

REEL PACK

PACKAGE	PACKING CODE	EA PER REEL	EA PER INNER BOX	COMPONENT SPACE (mm)	TAPE SPACE (mm)	REEL DIA (mm)	CARTON SIZE (mm)	EA PER CARTON	GROSS WEIGHT(Kg)
SOF2-4	-T	4,000	8,000				360*355*360	96,000	15

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